

## Preface

This book consists of papers presented during the 6<sup>th</sup> International Conference on Metallurgy Technology and Materials (ICMTM2018) which was held on 30-31 May 2018 in Xi'an, China. Like the first ICMTM held in Jeju Island, Korea (2012), the 2<sup>nd</sup> in Hong Kong, China (2013), the 3<sup>rd</sup> in Kunming, China (2014), the 4<sup>th</sup> in Singapore (2016) and the 5<sup>th</sup> in Xiamen, China (2017), the conference focuses on the structural materials, metallurgical technologies, polymers and modern composites, functional ceramics, technologies of coatings and surface engineering, nanomaterials for the various applications, chemical technologies in the ore processing and bio-production, building materials. The conference and the publications arising from it will trigger further related research and technological improvements in these important fields. All papers submitted by the participants of the conference were subjected to a peer-review process by the conference program committee and international reviewers. On behalf of the organizing committee, the editor would like to acknowledge the support and help of those involved in reviewing the papers and thank all of the authors for their contributions to this proceeding book.

Warmest regards,

Guest editor

Professor Dr Nor Sabirin Mohamed

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June 2018

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